



CDR5000

ELECTRICAL CHARACTERISTICS:

This filter satisfies Table 1 at Temperature Range: -40 to +85°C

CENTER FREQUENCY :fo=5825 MHz

PASSBAND WIDTH :5725~5925 MHz

INPUT/OUTPUT IMPEDANCE :50 Ω

Max. INPUT POWER

MOISTURE SENSITVITY LEVEL: 2A

5825 MHz **Ceramic Filter**

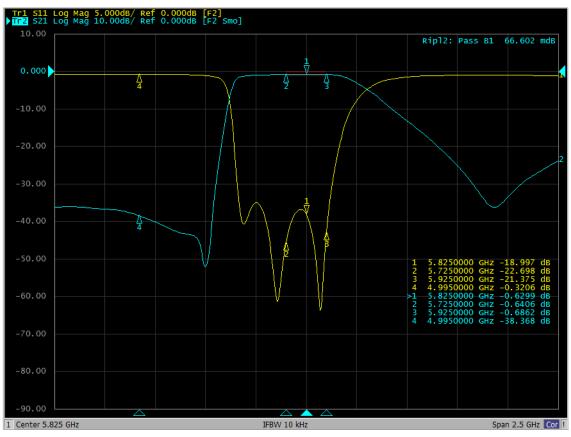
Package Dimensions

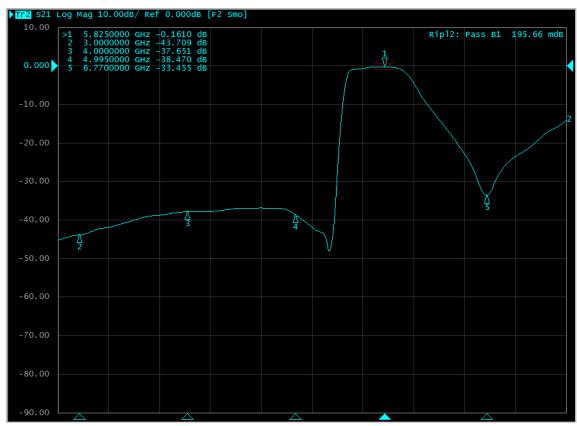
8.6 x 3.35 x 2.9 mm

TABLE 1

NO.	IT	SPECIFICATION					
	IT	Min	Тур	Max			
1	PASS BAND IN		1.0 dB	1.5 dB			
2	PASS BA		1.0 dB	1.2 dB			
3	PASS BAND	10 dB	12 dB				
4	STOP—BAND ATTENUATION	at 4995 MHz	35 dB	37 dB			
Item NO.4 specifies the absolute value of attenuation.							

TYPICAL ELECTRICAL CHARACTERISTICS





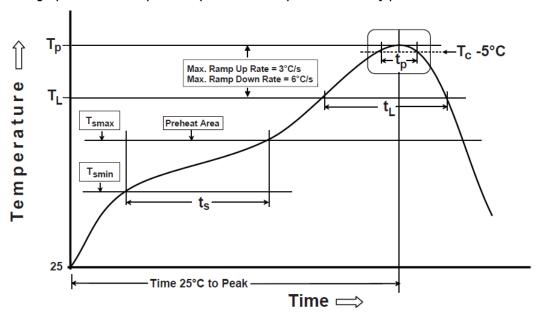
2. Recommended Reflow Soldering Profile

The products can be assembled following Pb-free assembly. According to the Standard IPC/ JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile features	Pb-Free Assembly (SnAgCu)		
PREHEAT	-Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(ts) form (Tsmin to Tsmax)	150°C 200°C 60-120 seconds		
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)		
REFLOW	-Temperature(TL) -Total Time above TL (t L)	217°C 30-100 seconds		
PEAK	-Temperature(TP) -Time(tp)	260°C 3 second		
RAMP-DOWN	Rate	6°C / second max.		
Time from 25°℃	to Peak Temperature	8 minutes max.		
Composition of se	older paste	96.5Sn/3Ag/0.5Cu		
Solder Paste Mod	lel	SHENMAO PF606-P26		

Note: All the temperature measure point is on top surface of the component, if temperature over recommend, it will make component surface peeling or damage.

The graphic shows temperature profile for component assembly process in reflow ovens



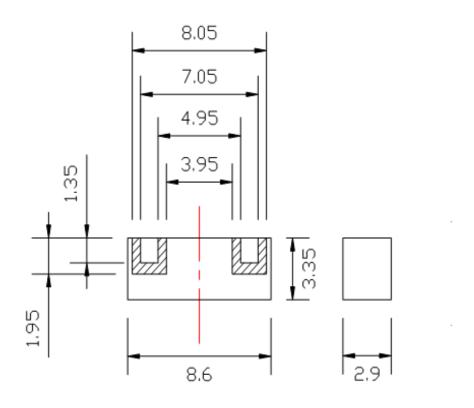
Soldering With Iron:

Soldering condition : Soldering iron temperature 270 ± 10 °C.

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron over temperature 270±10 °C or 3 seconds, it will make component surface peeling or damage. Soldering iron can not leakage of electricity.

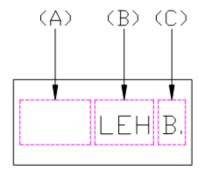
3.DIMENSION AND PCB LAYOUT

3-1-1 SHAPE AND DIMENSION



Dimensions in mm Tolerance : ±0.25

3-1-2 MARKING



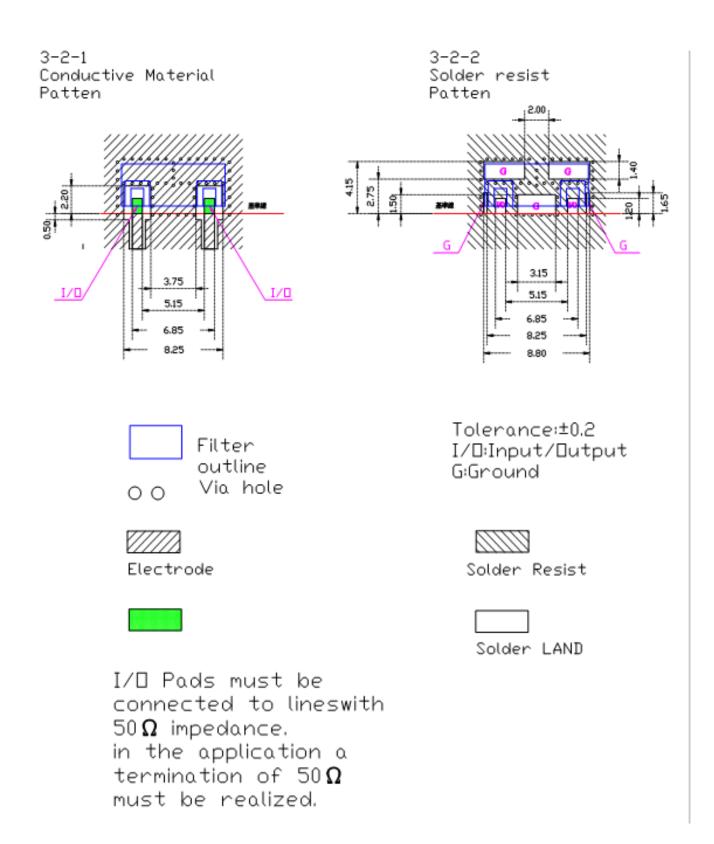
Product name: LEH for 5825H

B. = Year/Month: Please refer to the Table-1

(Table-1)

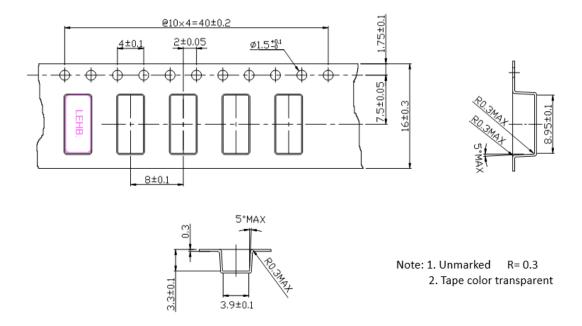
Year	Month	Code									
2012 2016 2020 2024	1	A	2013 2017 2021 2025	1	N	2014 2018 2022 2026	1	Α.	2015 2019 2023 2027	1	Ν.
	2	В		2	P		2	В.		2	Р.
	3	С		3	Q		3	С.		3	Q.
	4	D		4	R		4	D.		4	R.
	5	Е		5	S		5	Ε.		5	S.
	6	F		6	Т		6	F.		6	Τ.
	7	G		7	U		7	G.		7	U.
	8	Н		8	V		8	Н.		8	V.
	9	J		9	W		9	J.		9	W.
	10	K		10	X		10	Κ.		10	Χ.
	11	L		11	Y		11	L.		11	Υ.
	12	M		12	Z		12	М.		12	Ζ.

3-2 PCB RECOMMENDED PATTERN FOR FILTER

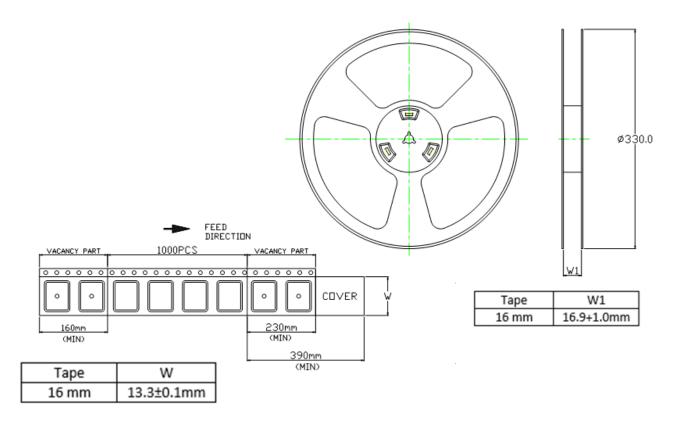


3-3 Delivery mode

3-3-1 Carrier tape



3-3-2 Reel





- 1. The design, manufacturing process, and specifications of this device are subject to change. 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.